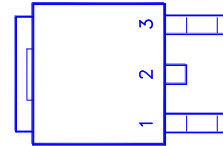
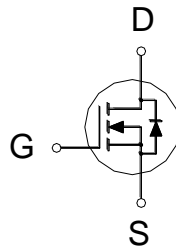




**PRODUCT SUMMARY**

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
150V	90mΩ	18A



- 1. GATE
- 2. DRAIN
- 3. SOURCE

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ °C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	150	V
Gate-Source Voltage		$V_{GS}$	±20	V
Continuous Drain Current	$T_C = 25\text{ °C}$	$I_D$	18	A
	$T_C = 100\text{ °C}$		11	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	37	
Avalanche Current		$I_{AS}$	8	
Avalanche Energy	$L = 1\text{mH}$	$E_{AS}$	32	mJ
Power Dissipation	$T_C = 25\text{ °C}$	$P_D$	56	W
	$T_C = 100\text{ °C}$		22.7	
Junction & Storage Temperature Range		$T_J, T_{stg}$	-55 to 150	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		1.8	°C / W
Junction-to-Ambient	$R_{\theta JA}$		62.5	

<sup>1</sup>Pulse width limited by maximum junction temperature.

**ELECTRICAL CHARACTERISTICS ( $T_J = 25\text{ °C}$ , Unless Otherwise Noted)**

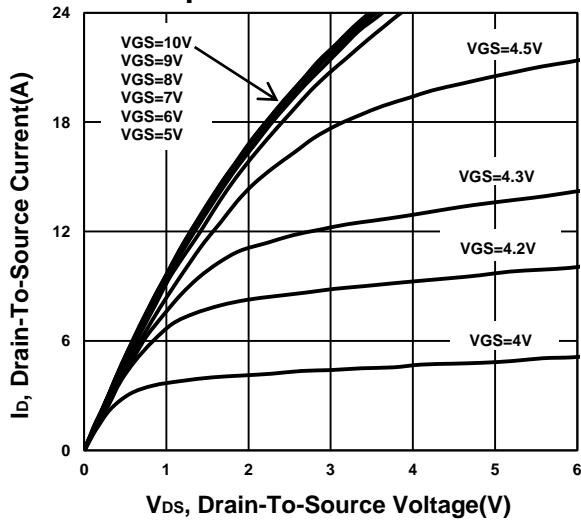
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	150			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.3	1.8	2.3	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			±100	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 120V, V_{GS} = 0V$			1	μA
		$V_{DS} = 100V, V_{GS} = 0V, T_J = 125\text{ °C}$			10	

Drain-Source On-State Resistance <sup>1</sup>	$R_{DS(ON)}$	$V_{GS} = 4.5V, I_D = 10A$	80	110	m $\Omega$
		$V_{GS} = 10V, I_D = 10A$	76	90	
Forward Transconductance <sup>1</sup>	$g_{fs}$	$V_{DS} = 5V, I_D = 10A$	35		S
<b>DYNAMIC</b>					
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$	1119		pF
Output Capacitance	$C_{oss}$		106		
Reverse Transfer Capacitance	$C_{rss}$		50		
Gate Resistance	$R_g$	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$	0.9		$\Omega$
Total Gate Charge <sup>2</sup>	$Q_g$	$V_{DS} = 75V, V_{GS} = 10V, I_D = 10A$	$V_{GS} = 10V$	24	nC
			$V_{GS} = 4.5V$	13	
Gate-Source Charge <sup>2</sup>	$Q_{gs}$		3.3		
Gate-Drain Charge <sup>2</sup>	$Q_{gd}$		7		
Turn-On Delay Time <sup>2</sup>	$t_{d(on)}$		21	nS	
Rise Time <sup>2</sup>	$t_r$		34		
Turn-Off Delay Time <sup>2</sup>	$t_{d(off)}$		30		
Fall Time <sup>2</sup>	$t_f$		22		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_J = 25^\circ C</math>)</b>					
Continuous Current	$I_S$			15	A
Forward Voltage <sup>1</sup>	$V_{SD}$	$I_F = 10A, V_{GS} = 0V$		1.2	V
Reverse Recovery Time	$t_{rr}$	$I_F = 10A, di_F/dt = 100A / \mu S$	55		nS
Reverse Recovery Charge	$Q_{rr}$		96		nC

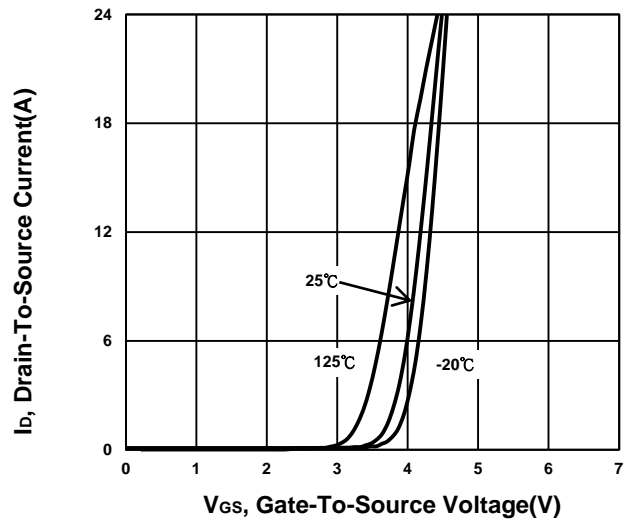
<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu sec$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

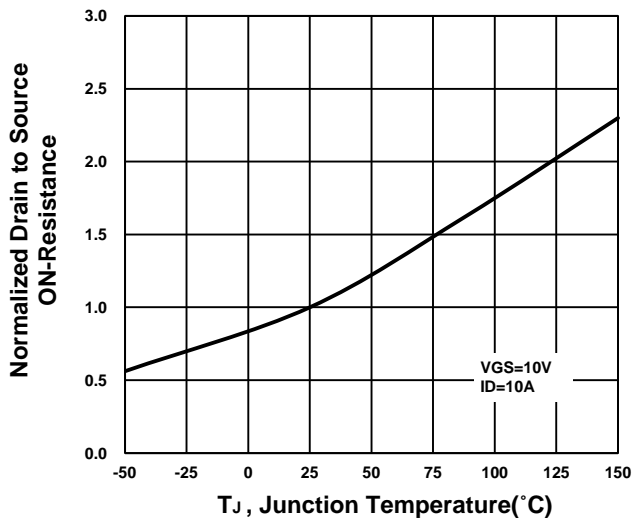
**Output Characteristics**



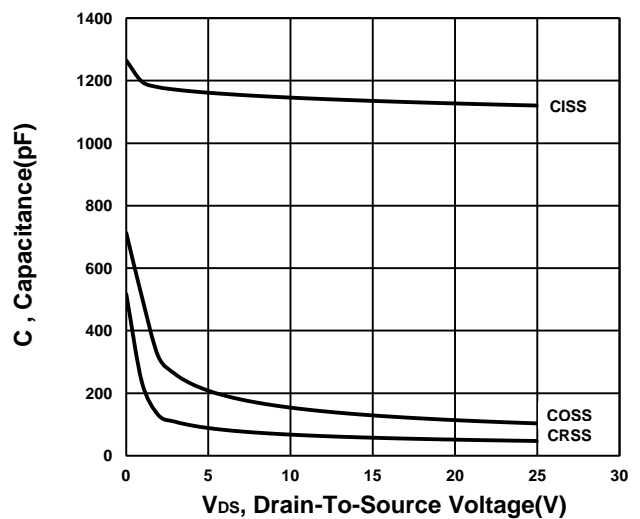
**Transfer Characteristics**



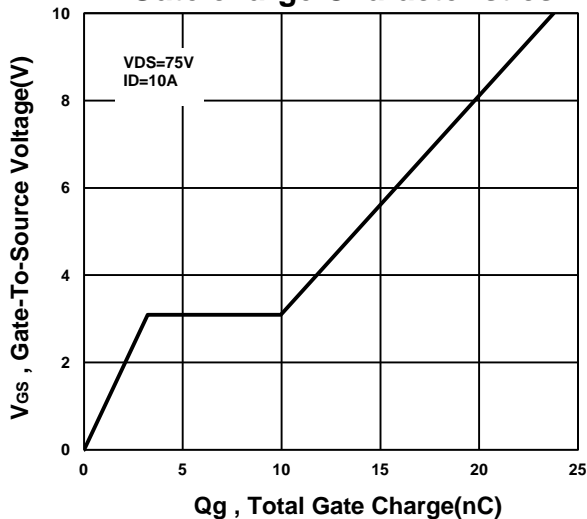
**On-Resistance VS Temperature**



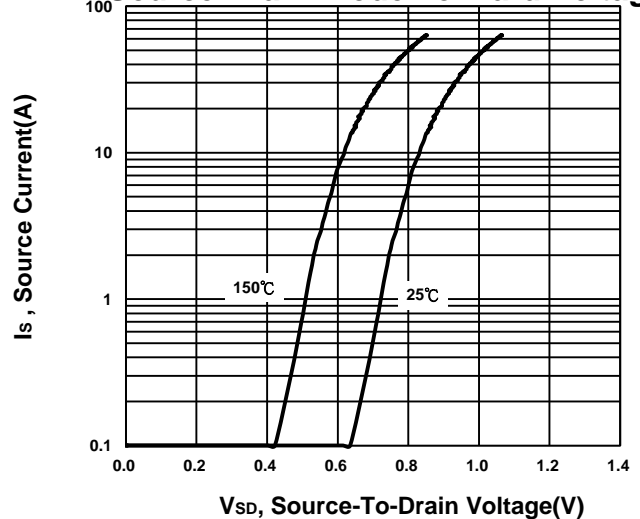
**Capacitance Characteristic**



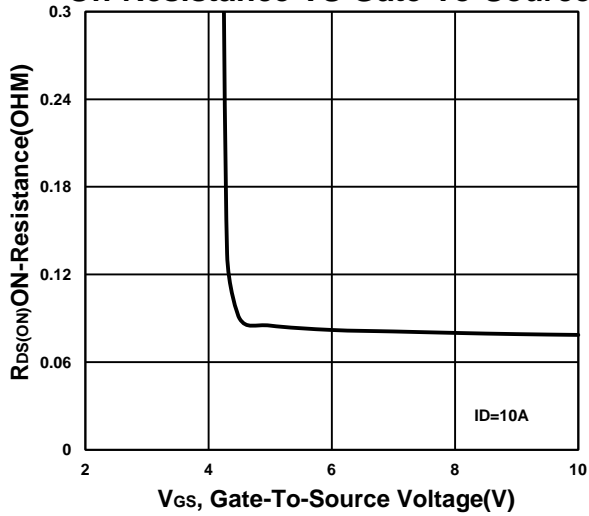
**Gate charge Characteristics**



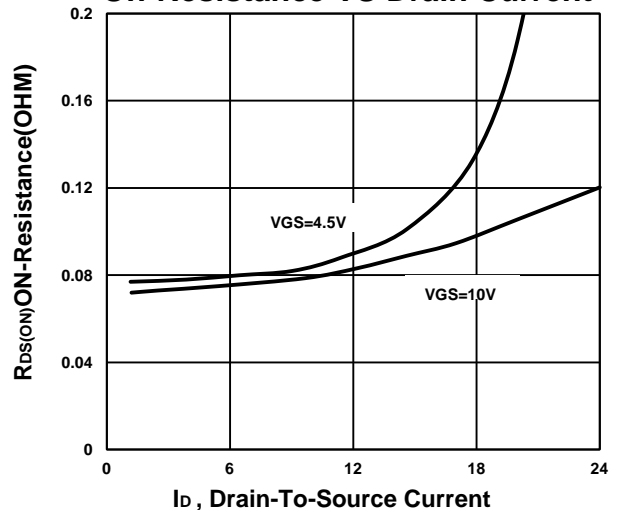
**Source-Drain Diode Forward Voltage**



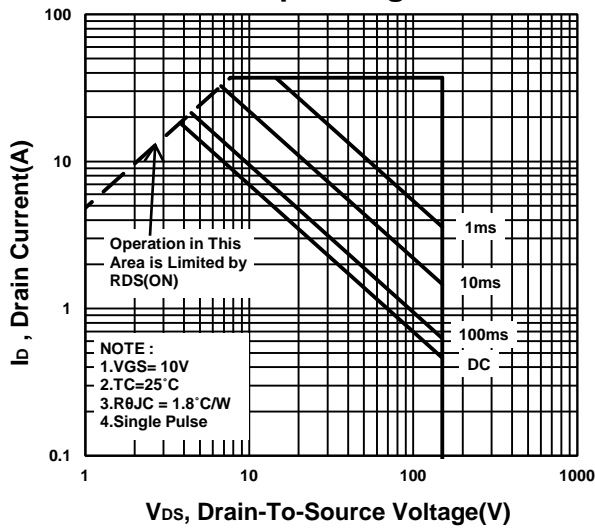
**On-Resistance VS Gate-To-Source**



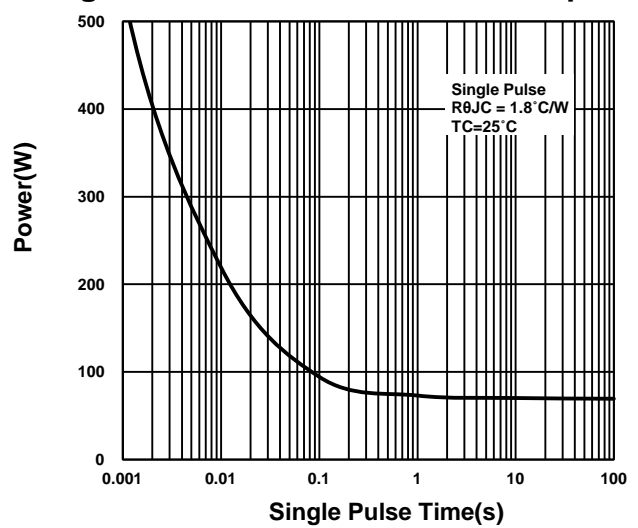
**On-Resistance VS Drain Current**



**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

